

## Marki 关于 P 封装替代 A 封装的说明

M1-M9 系列混频器，2017 年之前采用 A 封装，盖封装成本高，Marki 已经停产，用 P 封装建议。如果客户一定要用 A 封装，Marki 也可提供，但是大幅提价，预计每个产品贵 300 美金左右。

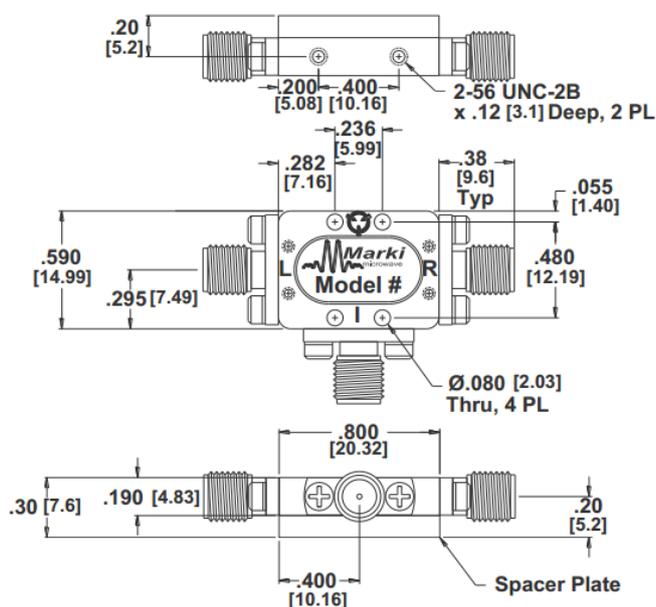
A 和 P 封装异同：

1. A 封装接头可拆卸，P 封装不可拆卸；
2. A 和 P 封装长度、长度一样，厚度 A 为 4.83mm，P 厚度为 10.4mm。

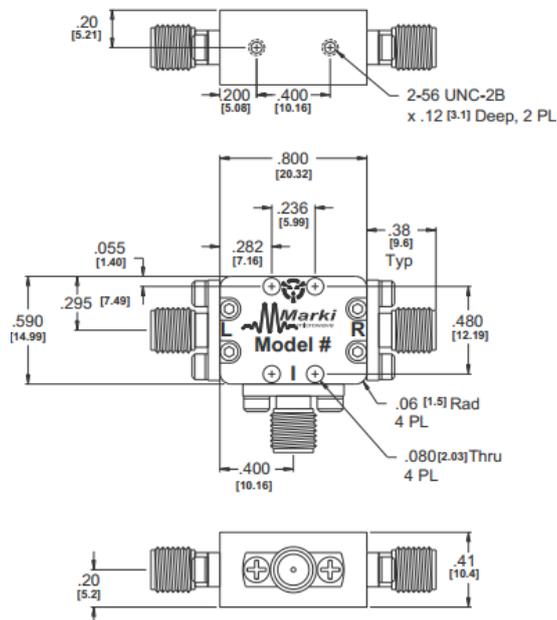
具体可参考 A 和 P 封装尺寸图。

Pricing for “A” package has significantly increased due to the complex and involved nature of the assembly process. We recommend customers move to “P” package which is basically the same packaging. The difference is the “A” package is solder sealed and the “P” package has a spacer on top for the cover.

The “P” package is recommended over the “A” package because it is easier and faster to assemble and the pricing is much lower than the “A” package.



左边：A 封装



右边：P 封装

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